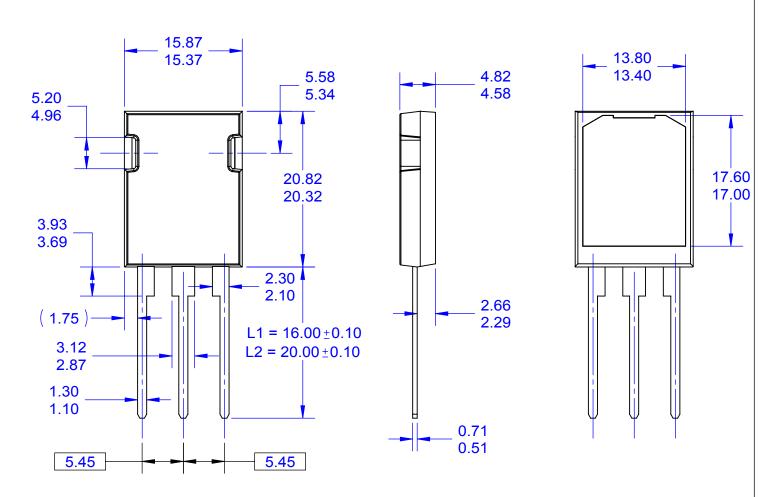
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NOTES:

- A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- F. DRAWING FILE NAME: TO247D03REV1

APPROVALS	DATE						
BOBOY MALDO	05MAR09	FAIRCHILD					
CHECKED: KH LEE		SEMICONDUCTOR TM					
APPROVED: BY HUANG		3LD, POWER TO247 NON JEDEC					
APPROVED: HOWARD ALLEN							
PROJECTION [MM]	SCALE 1:1	N/A	TO247	D03	REV 1		
INCH	FORMERLY: N/A			SHEET: 1 OF 1			